

WG75N65MFW1

Rev.01 - 21 March 2024

Product data sheet

1. General description

WG75N65MFW1 uses advanced Fine Trench Field-stop IGBT technology with antiparallel diode in TO-247 package to provide extremely low Vce(sat), and excellent switching performance. This device is ideal for wide range switching frequency converters.



2. Features and benefits

- Maximum junction temperature 175 °C
- Positive Temperature efficient for easy paralleling
- Very soft, fast recovery anti-parallel diode
- Smooth & Optimized switching
- EMI Improved Design

3. Applications

- Motor control
- PFC
- UPS
- Resonant converters
- · Mid to high range switching frequency converters

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter		Notes	Value		Unit	
V_{CE}	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$			650		V	
I _C	DC collector current, limited by $T_{j(max)}$ T _c = 100 °C				75		A
Symbol	Parameter Conditions		Notes	Min	Тур	Max	Unit
Static cha	racteristics						
$V_{\text{CE(sat)}}$	Collector-emitter saturation voltage	V _{GE} = 15 V; I _C = 75 A; T _j = 25 °C		-	1.5	2.1	V

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		۰C
2	С	collector		
3	E	emitter		
mb	С	mounting base; connected to collector	r 2 3 TO247	G E sym200

6. Ordering information

Table 3. Ordering in	formation					
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
WG75N65MFW1	TO247	WG75N65MFW1Q	Tube	30	SOT429	25-Mar-2013

7. Marking

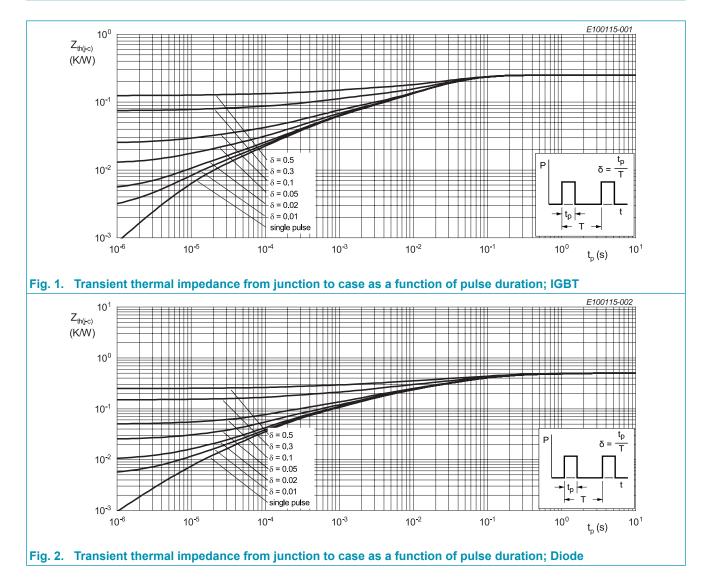
Table 4. Marking codes		
Type number	Marking codes	
WG75N65MFW1	G75N65	
	MFW1	

8. Limiting values

Symbol	Parameter	Notes	Value	Unit
V _{CE}	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$		650	V
I _C	DC collector current, limited by $T_{j(max)}$ T _c = 25 °C T _c = 100 °C		150 75	A
I _{C(puls)}	Pulsed collector current, t_p limited by $T_{j(max)}$		225	А
-	Turn off safe operating area $V_{CE} \le 650 \text{ V}, \text{ T}_{j} \le 175 \text{ °C}, \text{ t}_{p} = 1 \mu\text{s}$		225	A
I _F	Diode forward current, limited by $T_{j(max)}$ T _c = 25 °C T _c = 100 °C		150 75	A
I _{Fpuls}	Diode pulsed current, t_p limited by $T_{j(max)}$		225	А
V_{GE}	Gate-emitter voltage		±20	V
P _{tot}	Power dissipation $T_c = 25 \degree C$ Power dissipation $T_c = 100 \degree C$		600 300	W
t _{sc}	Short circuit withstand time $V_{GE} = 15.0 \text{ V}, V_{CC} \le 400 \text{ V}$ Allowed number of short circuits < 1000 Time between short circuits: $\ge 1.0 \text{ s}$ $T_j = 175^{\circ}\text{C}$		5	us
T _{stg}	Storage temperature		-55 to +150	°C
T _{jmax}	Maximum operating junction temperature		175	°C
-	Peak soldering temperture		260	°C
М	Mounting Torque with washer		0.55	Nm

9. Thermal characteristics

Table 6. Th	ermal characteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
R _{th(j-c)}	IGBT thermal resistance from junction to case			-	0.25	-	K/W
R _{th(j-c)}	Diode thermal resistance from junction to case			-	0.5	-	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient			-	40	-	K/W



10. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics	·					
BV_{CES}	Collector-emitter breakdown voltage	V _{GE} = 0 V; I _C = 1.0 mA		650	-	-	V
V _{CE(sat)}	Collector-emitter saturation	V _{GE} = 15 V; I _C = 75 A; T _j = 25 °C		-	1.5	2.1	V
	voltage	V _{GE} = 15 V; I _C = 75 A; T _j = 175 °C		-	1.85	-	V
V _F [Diode forward voltage	V _{GE} = 0 V; I _F = 75 A; T _j = 25 °C		-	1.9	-	V
		V _{GE} = 0 V; I _F = 75 A; T _j = 175 °C		-	1.6	- \\	V
$V_{\text{GE(th)}}$	Gate-emitter threhold voltage	I _c = 375 μA; V _{ce} = V _{ge}		3.6	4.8	6.0	V
I _{CES}	Zero gate voltage collector	V_{ce} = 650 V; V_{ge} = 0 V; T_{j} = 25 °C		-	-	100	μA
	current	V _{CE} = 650 V; V _{GE} = 0 V; T _j = 175 °C		-	-	1	V
g _{fs}	Transconductance	V _{CE} = 20 V; I _C = 75 A		-	42	-	S
Dynamic	characteristics						
C _{ies}	Input capacitance	V _{CE} = 30 V; V _{GE} = 0 V; f = 1 MHz;		-	4307	-	pF
C _{oes}	Output capacitance	T _j = 25 °C		-	136	-	pF
C _{res}	Reverse transfer capacitance			-	59	-	pF
Q _G	Gate charge	V _{CC} = 520 V; I _C = 75 A; V _{GE} = 15 V; T _i = 25 °C		-	210	-	nC

Unit

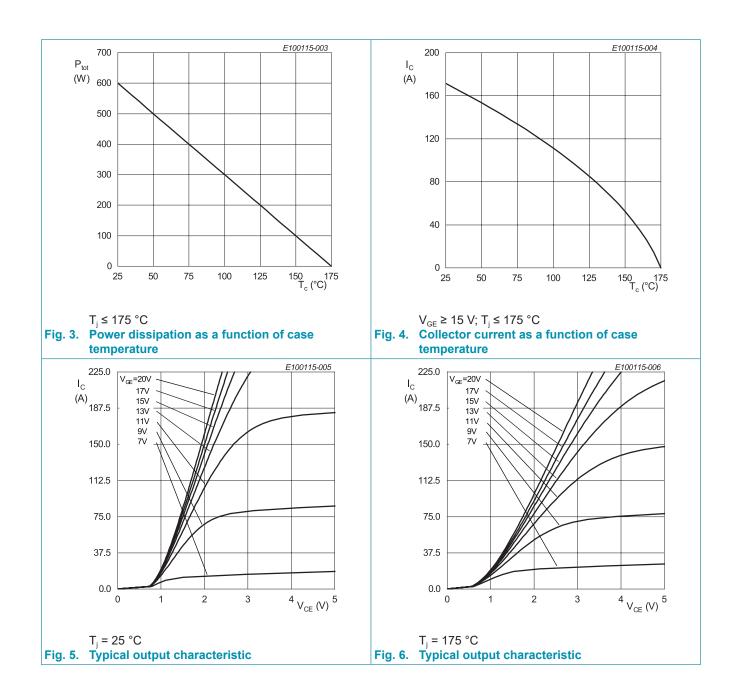
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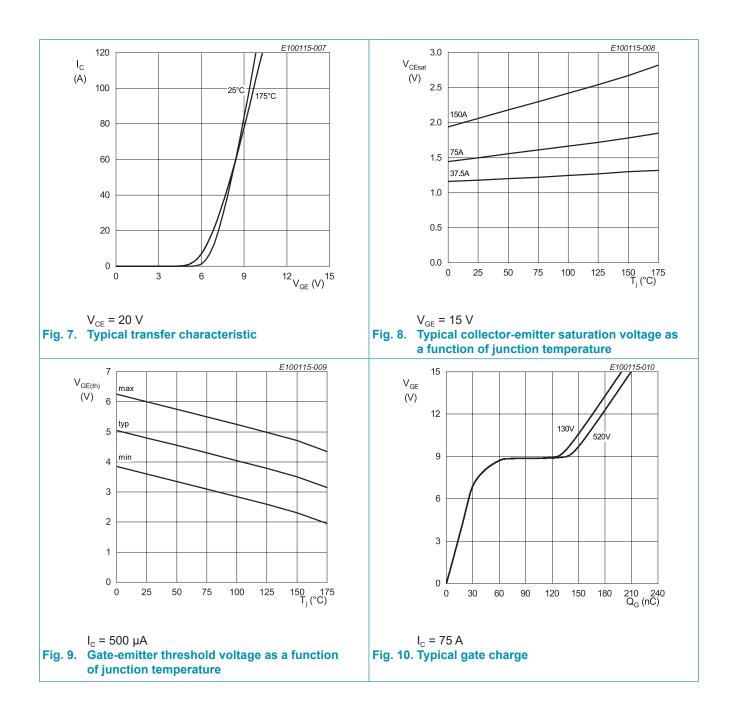
nS nC А

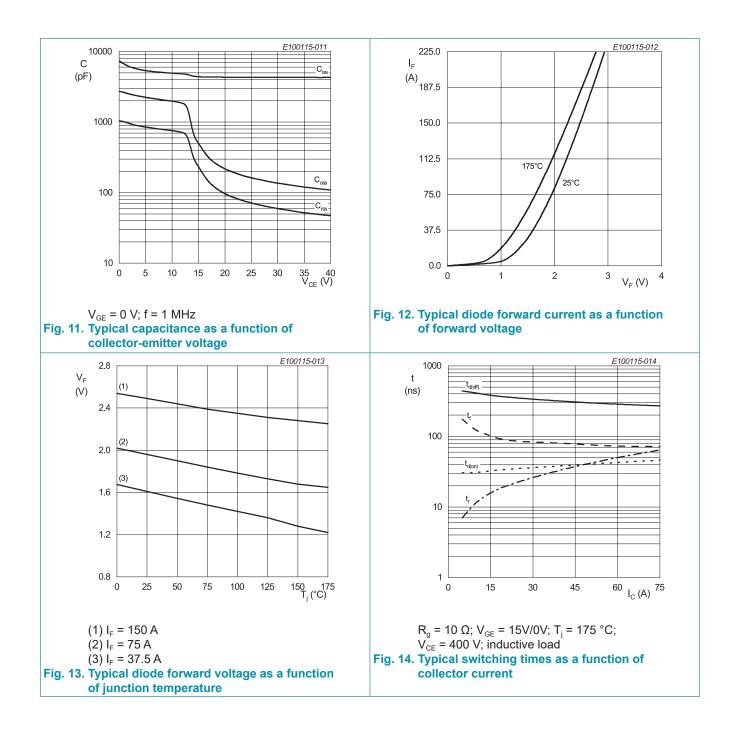
nS nC А

11 4 0

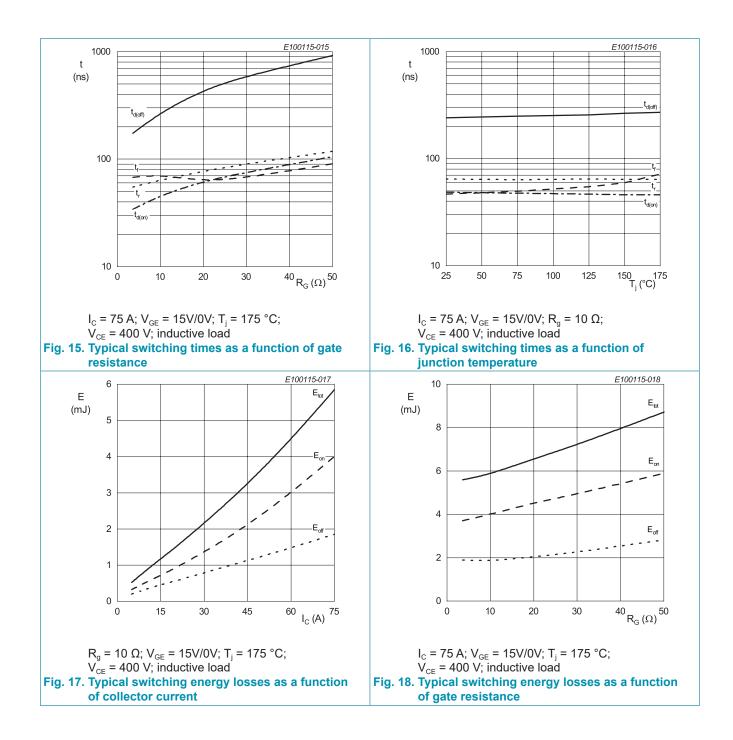
11. Sw	itching Character	ristics				
Table 8. Sv	witching Characteristics, Ir	nductive Load				
Symbol	Parameter	Conditions	Notes	Min	Тур	Max
IGBT cha	racteristics					
t _{d(on)}	Turn-on delay time	$T_j = 25 °C;$		-	48	-
t,	Rise time	$V_{cc} = 400 \text{ V}; \text{ I}_{c} = 75 \text{ A}; \text{ V}_{GE} = 15 \text{ V} / 0 \text{ V};$ R _G = 10 Ω		-	64	-
t _{d(off)}	Turn-off delay time			-	241	-
t _f	Fall time			-	46	-
E _{on}	Turn-on energy			-	2.5	-
E _{off}	Turn-off energy			-	1.4	-
E _{ts}	Total switching energy			-	3.9	-
t _{d(on)}	Turn-on delay time	$T_j = 175 \text{ °C};$ $V_{CC} = 400 \text{ V}; I_C = 75 \text{ A}; V_{GE} = 15 \text{ V} / 0 \text{ V};$ $R_G = 10 \Omega$		-	46	-
t _r	Rise time			-	64	-
t _{d(off)}	Turn-off delay time			-	271	-
t _f	Fall time			-	72	-
E _{on}	Turn-on energy			-	4	-
E _{off}	Turn-off energy			-	1.85	-
E _{ts}	Total switching energy			-	5.85	-
Diode cha	aracteristics			,		
t _{rr}	Reverse recovery time	T _j = 25 °C;		-	70	-
Q _r	Reverse recovery charge	$V_{R} = 400 \text{ V}; \text{ I}_{F} = 75 \text{ A}; \text{ dI}_{F}/\text{dt} = 700 \text{ A}/\text{us}$		-	871	-
I _{RM}	Reverse recovery peak current			-	25	-
t _{rr}	Reverse recovery time	$T_{j} = 175 \text{ °C};$		-	127	-
Q _r	Reverse recovery charge	V_{R} = 400 V; I _F = 75 A; dI _F /dt = 700A/us		-	2994	-
I _{RM}	Reverse recovery peak current			-	39	-

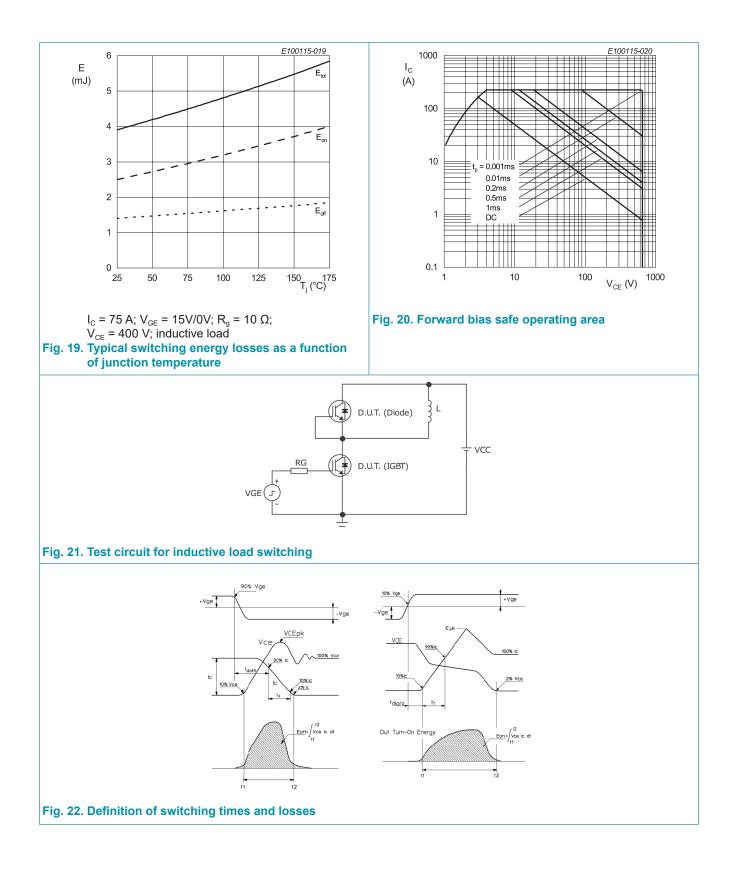




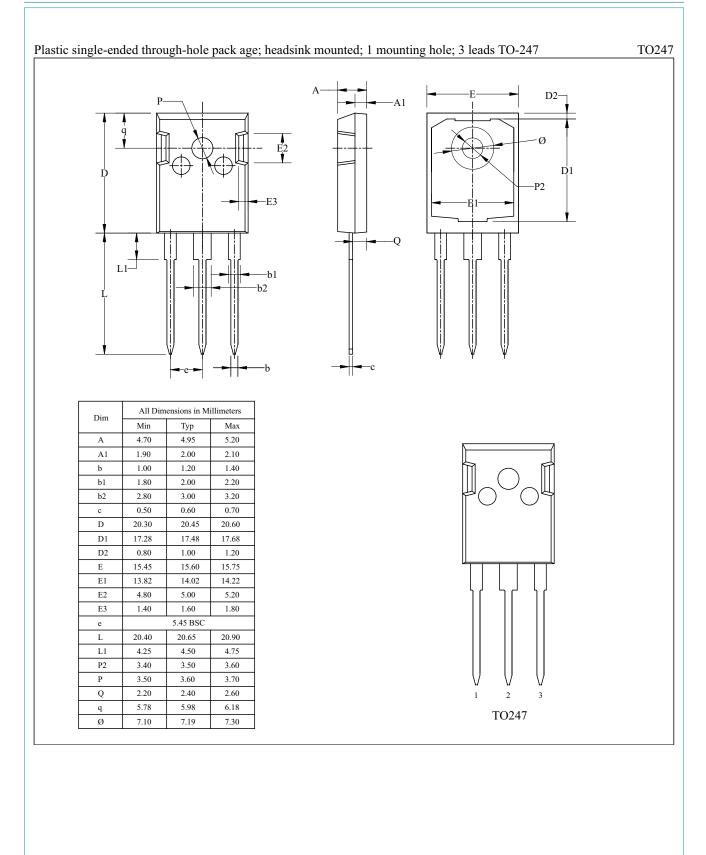








12. Package outline



WG75N65MFW1

13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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